

LIST OF PUBLICATIONS CITED BY APPLICANT	<u>Atty Docket No.</u> SEL 233	<u>Serial No.</u> 09/747,731
	<u>Applicant</u> Shunpei YAMAZAKI et al	
	<u>Filing Date</u> December 22, 2000	<u>Group</u> 1762

US PATENT DOCUMENTS

*EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUB- CLASS	FILING DATE

FOREIGN PATENT DOCUMENTS

	DOCUMENT NUMBER	DATE	APPLICANT	English Abstract	English Trans.	FILING DATE
WPF	JP 10-41069	02/13/98	Toray Industries Inc.		X	03/27/97

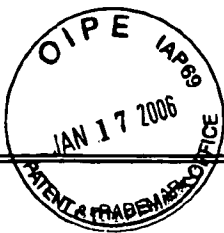
OTHER PRIOR ART - NON PATENT LITERATURE DOCUMENTS

(Include name of author (in CAPITAL LETTERS), title of article or item (book, magazine, journal, serial, symposium, catalog, etc.) date, pages(s), volume-issue number(s), publisher, city and/or country where published).

WPF	1) Japanese document for submission of publication re Japanese patent application no. JP 2000-394259, dated March 24, 2005 (with English translation).
WPF	2) Japanese Patent Office notification re Japanese patent application no. JP 2000-394259, dated May 30, 2005.

EXAMINER: <i>William Phillips Fitch</i>	DATE CONSIDERED: 2/17/2006
---	----------------------------

*EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP form. Draw line through citation if not in conformance and not considered. Include a copy of this form with the next communication to applicant.



LIST OF PUBLICATIONS CITED BY APPLICANT			Att'y. Docket No. SEL 233	Serial No. 09/747,731		
			Applicant Shunpei YAMAZAKI et al			
			Filing Date December 22, 2000	Group 1762		
US PATENT DOCUMENTS						
*EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUB- CLASS	FILING DATE
WPF ↓ ✓	2,351,536	06/13/44	Osterberg et al	117	107	04/25/41
	3,312,190	04/04/67	Bradshaw	118	49.1	02/25/64
	3,543,717	12/01/70	Adachi	118	7	04/25/68
	3,636,305	01/18/72	Passmore	219	271	03/10/71
	3,756,193	09/04/73	Carmichael et al	118	49.1	05/01/72
	3,931,789	01/13/76	Kakei et al	118	49	04/19/74
	3,971,334	07/27/76	Pundsack	118	5	03/04/75
	4,225,805	07/29/80	Smithgall et al	313	481	12/22/78
	4,233,937	11/18/80	Steube	118	727	07/20/78
	4,405,487	09/20/83	Harrah et al	252	194	04/29/82
	4,543,467	09/24/85	Eisele et al	219	271	10/25/83
	4,592,306	06/03/86	Gallego	118	719	11/30/84
	4,602,192	07/22/86	Nomura et al	315	169.3	11/27/84
	4,672,265	06/09/87	Eguchi et al	313	504	07/28/85
	4,951,601	08/28/90	Maydan et al	118	719	06/23/89
	5,190,590	03/02/93	Suzuki et al	118	664	04/08/91
	5,259,881	11/09/93	Edwards et al	118	719	05/17/91
	5,310,410	05/10/94	Begin et al	29	25.01	12/13/91
	5,512,320	04/30/96	Turner et al	427	255	04/13/94
	5,534,314	07/09/96	Wadley et al	427	585	08/31/94
	5,550,066	08/27/96	Tang et al	437	40	12/14/94
	5,643,685	07/01/97	Torikoshi	428	690	10/19/94
	5,670,792	09/23/97	Utsugi et al	257	59	10/12/94
	5,844,363	12/01/98	Gu et al	313	506	01/23/97
	5,902,688	05/11/99	Antoniadis et al	428	690	07/16/96
	5,904,961	05/18/99	Tang et al	427	561	01/24/97
	5,906,857	05/25/99	McKee et al	427	8	05/13/97
	5,921,836	07/13/99	Nanto et al	445	24	01/27/97
	5,935,395	08/10/99	Ouellet et al	204	298.07	06/20/96
	5,943,600	08/24/99	Ngan et al	438	653	03/31/97
	5,945,967	08/31/99	Rallison et al	345	32	04/21/95
	5,972,183	10/26/99	Krueger et al	204	298.07	09/01/95
	6,001,413	12/14/99	Matsuura et al	427	64	03/06/98
	6,011,904	01/04/00	Mattord	392	389	06/10/97
	6,023,308	02/08/00	Takemura	349	42	11/26/97
	6,049,167	04/11/00	Onitsuka et al	313	512	02/13/98

Shunpei Yamazaki

2/4/2006



LIST OF PUBLICATIONS
CITED BY APPLICANT

Attv. Docket No.
SEL 233

Serial No.
09/747,731

Applicant
Shunpei YAMAZAKI et
al

Filing Date
December 22, 2000

Group
1762

US PATENT DOCUMENTS

*EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUB- CLASS	FILING DATE
WPF ↓	6,124,215	09/26/00	Zheng	438	760	10/06/97
	6,132,805	10/17/00	Moslehi	427	248.1	10/20/98
	6,149,392	11/21/00	Conte	417	51	10/07/98
	6,280,861 B1	08/28/01	Hosokawa et al	428	690	01/21/99
	US 2001/ 0022272 A1	09/20/01	Plester et al	204	192.38	04/30/01
	6,299,746 B1	10/09/01	Conte et al	204	298.07	12/22/98
	6,294,892 B1	09/25/01	Utsugi et al	318	640	12/22/99
	6,296,894 B1	10/02/01	Tanabe et al	427	8	08/11/99
	6,319,321 B1	11/20/01	Hiraga et al	118	666	01/20/98
	6,333,065 B1	12/25/01	Arai et al	427	66	07/17/98
	6,337,105 B1	01/08/02	Kunieda et al	427	248.1	01/11/00
	6,340,501 B1	01/22/02	Kamiyama et al	427	255.6	04/05/00
	US 2002/ 0009538 A1	01/24/02	Arai	427	66	05/03/01
	6,380,081 B1	04/30/02	Lee	438	681	11/20/00
	US 2002/ 0081372 A1	06/27/02	Peng	427	64	01/17/01
	US 2002/ 0084032 A1	07/04/02	Jeng et al	156	345.31	02/26/02
	6,469,439 B2	10/22/02	Himeshima et al	313	506	03/20/01
	US 2002/ 0155632 A1	10/24/02	Yamazaki et al	438	29	02/20/02
	6,482,852 B2	11/19/02	Shakespeare et al	514	506	05/11/01
	6,495,198 B2	12/17/02	Peng	427	66	01/17/01
	US 2002/ 0192499 A1	12/19/02	Tokailin et al	428	690	03/27/01
	US 2002/ 0197418 A1	12/26/02	Mizukami et al	427	596	05/31/02
	US 2003/ 0015140 A1	01/23/03	Van Slyke et al	118	723	04/26/01
	US 2003/ 0017259 A1	01/23/03	Yamada et al	427	66	06/28/02
	US 2003/ 0024479 A1	02/06/03	Kashiwaya et al	118	726	07/31/02
	6,528,108 B1	03/04/03	Kawamura	427	8	09/25/00

Shunpei Yamazaki et al

2/17/2006



LIST OF PUBLICATIONS CITED BY APPLICANT	Atty. Docket No. SEL 233	Serial No. 09/747,731
	Applicant Shunpei YAMAZAKI et al	
	Filing Date December 22, 2000	Group 1762

US PATENT DOCUMENTS

*EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUB- CLASS	FILING DATE
WPF ↓	6,432,561 B1	08/13/02	Yamazaki	428	690	07/13/00
	6,537,607 B1	03/25/03	Swanson	427	66	11/16/00
	US 2003/ 0101937 A1	06/05/03	Van Slyke et al	118	726	11/28/01
	6,633,121 B2	10/14/03	Eida et al	313	504	01/23/01
	6,641,674 B2	11/04/03	Peng	118	727	05/31/02
	6,649,210 B2	11/18/03	Tokailin et al	427	66	11/02/01
	6,660,409 B1	12/09/03	Komatsu et al	428	690	09/12/00
	6,696,096 B2	02/24/04	Tsubaki et al	427	69	06/21/01
	US 2004/ 0035366 A1	02/26/04	Keum et al	118	726	07/16/03
	US 2004/ 0096694 A1	05/20/04	Tokailin et al	428	690	06/30/03
	US 2004/ 0139984 A1	07/22/04	Yamazaki et al	134	1.1	01/05/04
	6,776,880 B1	08/17/04	Yamazaki	204	192.15	07/19/00
	US 2005/ 0005850 A1	01/13/05	Yamazaki	118	719	08/02/04

FOREIGN PATENT DOCUMENTS

DOCUMENT NUMBER	DATE	APPLICANT	English Abstract	English Trans.	FILING DATE

OTHER PRIOR ART - NON-PATENT LITERATURE DOCUMENTS
(Including Author, Title, Date, Pertinent Pages)

--	--

EXAMINER: <i>WPF</i>	DATE CONSIDERED: <i>2/17/2006</i>
*EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP form. Draw line through citation if not in conformance and not considered. Include a copy of this form with the next communication to applicant.	



FOREIGN PATENT DOCUMENTS

	DOCUMENT NUMBER	DATE	APPLICANT	English Abstract	English Trans.	FILING DATE
WPF ↓	DE 28 34 806	02/14/80	Leybold-Heraeus GMB	X		08/09/78
	JP 58-177463	10/18/83	Hitachi Ltd.	X		04/12/82
	JP 60-032361	03/05/85	Tsutiya		X	08/10/83
	JP 60-121616	06/29/85	Suwa Seikosha KK	X		12/06/83
	JP 63-079959	04/09/88	Anelva Corp.	X		09/20/86
	JP 64-042392	02/14/89	NEC Corp.	X		08/07/87
	JP 04-116169	04/16/92	Shin Meiwa Ind. Co.	X		09/05/90
	JP 05-304197	11/16/93	Hitachi Ltd.	X		04/27/92
	JP 06-088233	03/29/94	Ishikawajima Harima Heavy Ind. Co. Ltd.	X		09/04/92
	JP 06-306181	11/01/94	Agency of Ind. Sci. & Tech. Res. Dev...	X		03/12/93
	JP 07-192866	07/28/95	Ricoh Co. Ltd.	X		12/26/93
	JP 07-252671	10/03/95	Agency of Ind. Sci. & Tech. Daini...	X		03/09/94
	JP 09-209127	08/12/97	Idemitsu Kosan Co.	X		02/05/96
	JP 09-256142	09/30/97	Sony Corp.	X		03/15/96
	JP 10-168559	06/23/98	Ulvac Japan Ltd.	X		12/06/96
	JP 10-195639	07/28/98	Ulvac Japan Ltd.	X		01/09/97
	JP 10-335062	12/18/98	TDK Corp.		X	05/30/97
	JP 11-229123	08/24/99	Casio Comput Co Ltd	X		02/12/98
	EP 0 955 791	11/10/99	Toray Ind. Inc.			10/15/97
	JP 2000- 348859	12/15/00	Chisso Corp.	X		06/03/99
	WO 01/079581	10/25/01	Idemitsu Kosan Co.	X		03/27/01

OTHER PRIOR ART - NON-PATENT LITERATURE DOCUMENTS (Including Author, Title, Date, Pertinent Pages)

--

EXAMINER:

[Signature]

DATE CONSIDERED:

2/17/2006

*EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP form. Draw line through citation if not in conformance and not considered. Include a copy of this form with the next communication to applicant.